

S Series Power MOSFET

PRODUCT SUMMARY		
V_{DS} (V) at T_J max.	650	
$R_{DS(on)}$ max. at 25 °C (Ω)	$V_{GS} = 10$ V	0.07
Q_g max. (nC)	216	
Q_{gs} (nC)	39	
Q_{gd} (nC)	57	
Configuration	Single	

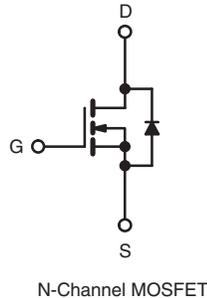
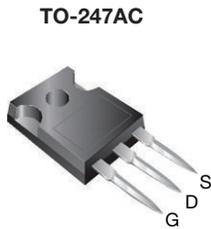
FEATURES

- Generation one
- Low figure-of-merit $R_{on} \times Q_g$
- 100 % avalanche tested
- Ultra low gate charge
- Ultra low R_{on}
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

APPLICATIONS

- PFC power supply stages
- Hard switching topologies
- Solar inverters
- UPS
- Motor control
- Server telecom



ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG47N60S-E3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	600	V	
Gate-Source Voltage		V_{GS}	± 30		
Continuous Drain Current ($T_J = 150$ °C)	V_{GS} at 10 V	I_D	$T_C = 25$ °C	47	A
			$T_C = 100$ °C	30	
Pulsed Drain Current ^a		I_{DM}	140		
Linear Derating Factor			3.3	W/°C	
Avalanche Energy (repetitive)		E_{AR}	0.42	mJ	
Single Pulse Avalanche Energy ^b		E_{AS}	1800		
Maximum Power Dissipation		P_D	417	W	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	$T_J = 125$ °C	dV/dt	37	V/ns	
Reverse Diode dV/dt ^d			8.5		
Soldering Recommendations (Peak Temperature) ^c	for 10 s		300	°C	

Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$ V, starting $T_J = 25$ °C, $L = 73.5$ mH, $R_g = 25$ Ω , $I_{AS} = 7$ A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$, $dI/dt = 100$ A/ μ s, starting $T_J = 25$ °C.



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.3	

SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$		600	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25\text{ }^\circ\text{C}$, $I_D = 1\text{ mA}$		-	0.7	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$		2	-	4	V
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20\text{ V}$		-	-	± 100	nA
		$V_{GS} = \pm 30\text{ V}$		-	-	± 1	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$		-	-	1	μA
		$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}, T_J = 150\text{ }^\circ\text{C}$		-	-	10	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$	$I_D = 24\text{ A}$	-	0.057	0.07	Ω
Forward Transconductance ^a	g_{fs}	$V_{DS} = 8\text{ V}, I_D = 3\text{ A}$		-	7.5	-	S
Dynamic							
Input Capacitance	C_{iss}	$V_{GS} = 0\text{ V}, V_{DS} = 100\text{ V}, f = 1\text{ MHz}$		-	6630	-	pF
Output Capacitance	C_{oss}			-	220	-	
Reverse Transfer Capacitance	C_{rss}			-	7	-	
Total Gate Charge	Q_g	$V_{GS} = 10\text{ V}$	$I_D = 20\text{ A}, V_{DS} = 400\text{ V}$	-	180	216	nC
Gate-Source Charge	Q_{gs}			-	39	-	
Gate-Drain Charge	Q_{gd}			-	57	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 380\text{ V}, I_D = 47\text{ A}, R_g = 4.4\text{ }\Omega, V_{GS} = 13\text{ V}$		-	30	60	ns
Rise Time	t_r			-	12	25	
Turn-Off Delay Time	$t_{d(off)}$			-	115	175	
Fall Time	t_f			-	9	20	
Gate Input Resistance	R_g	$f = 1\text{ MHz}, \text{open drain}$		-	0.62	-	Ω
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 		-	-	47	A
Pulsed Diode Forward Current	I_{SM}			-	-	140	
Body Diode Voltage	V_{SD}	$T_J = 25\text{ }^\circ\text{C}, I_S = 47\text{ A}, V_{GS} = 0\text{ V}$		-	-	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$T_J = 25\text{ }^\circ\text{C}, I_F = I_S, dI/dt = 100\text{ A}/\mu\text{s}, V_R = 25\text{ V}$		-	750	1125	ns
Body Diode Reverse Recovery Charge	Q_{rr}			-	18	36	μC
Body Diode Reverse Recovery Current	I_{RRM}			-	39	80	A

Note

a. $C_{oss\text{ eff.}}$ (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

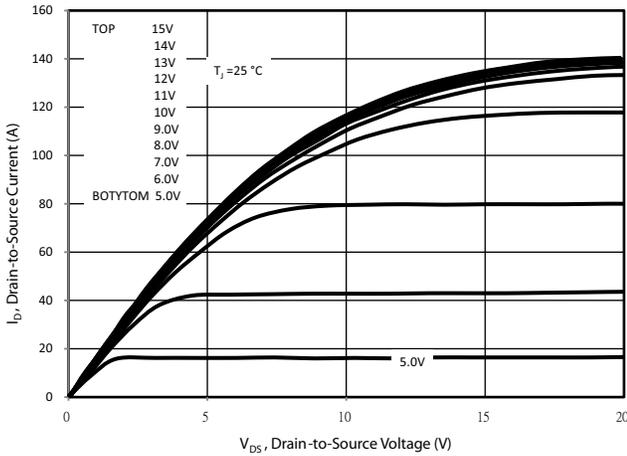


Fig. 1 - Typical Output Characteristics (TO-247)

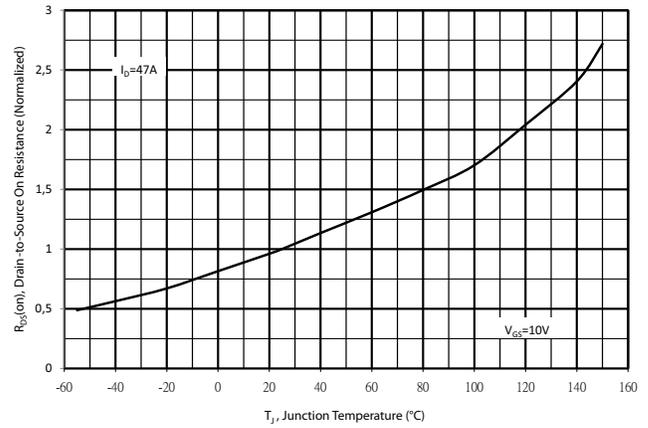


Fig. 4 - Normalized On-Resistance vs. Temperature

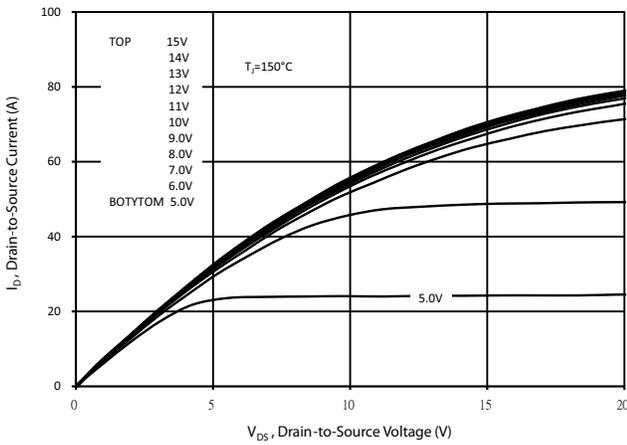


Fig. 2 - Typical Output Characteristics (TO-247)

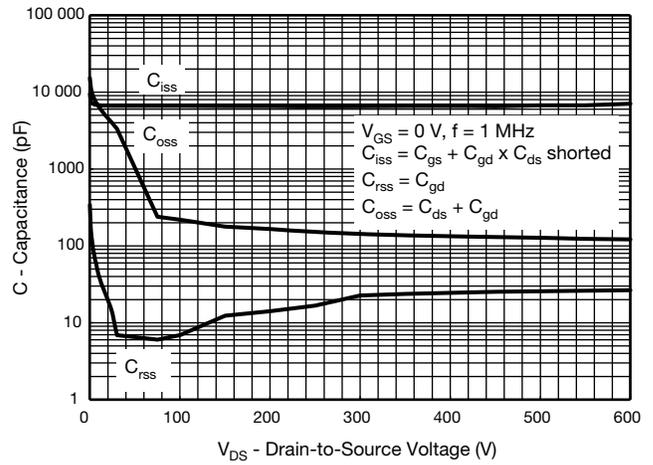


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

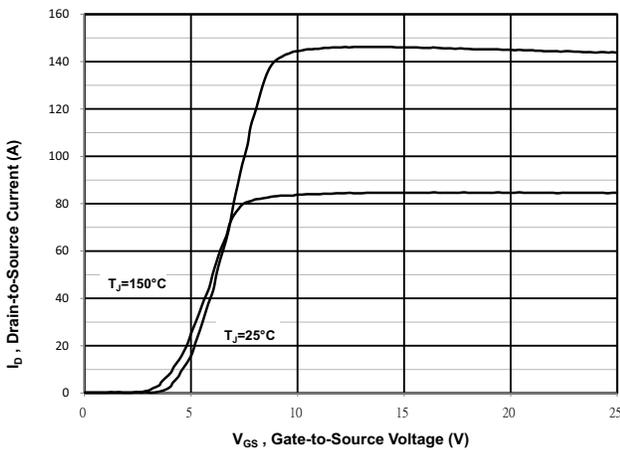


Fig. 3 - Typical Transfer Characteristics

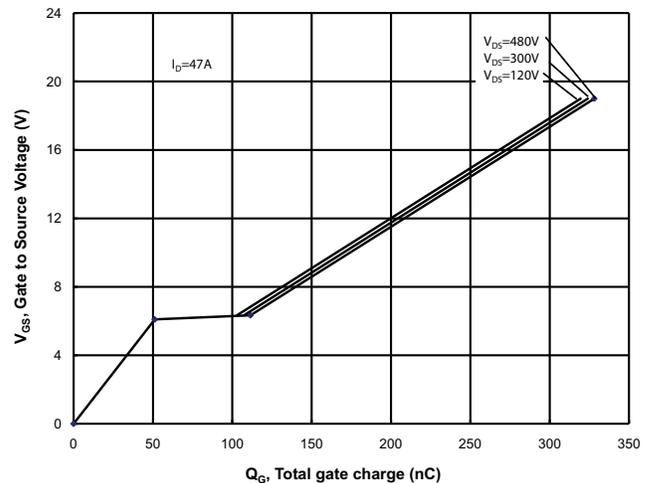


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

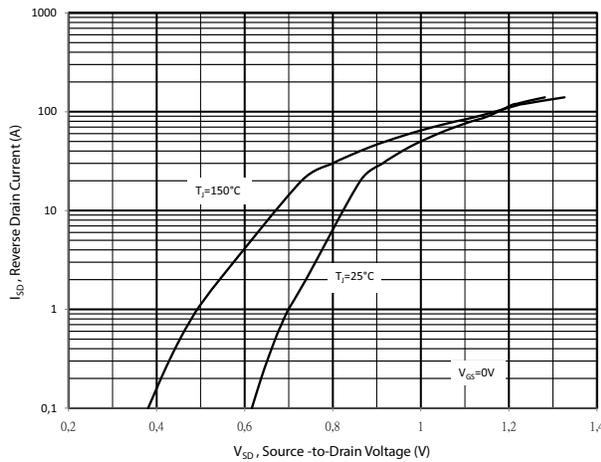


Fig. 7 - Typical Source-Drain Diode Forward Voltage

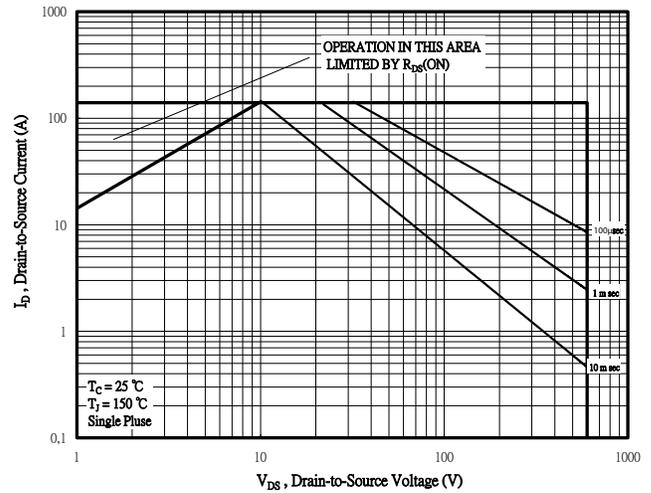


Fig. 8 - Maximum Safe Operating Area

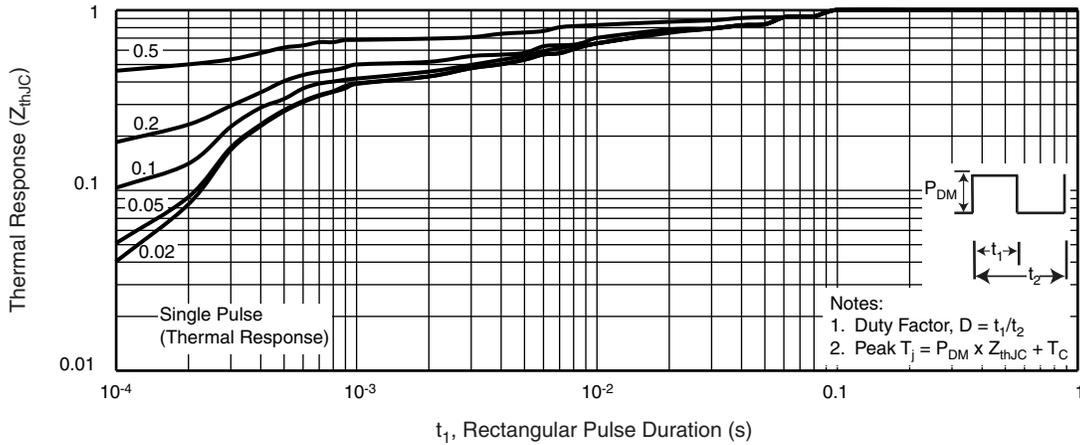


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-247AC)

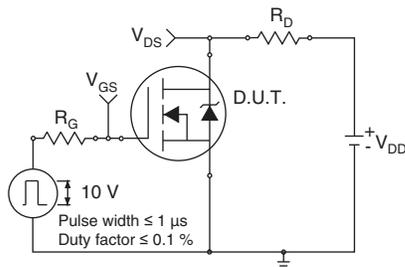


Fig. 10 - Switching Time Test Circuit

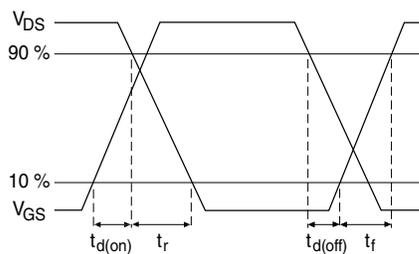


Fig. 11 - Switching Time Waveforms

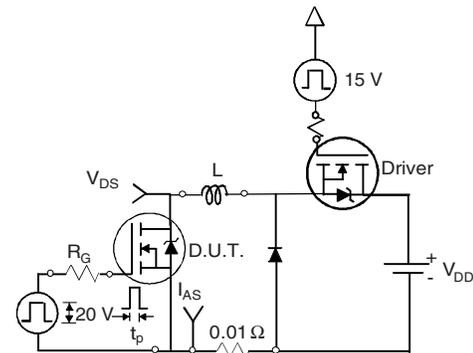


Fig. 12 - Unclamped Inductive Test Circuit

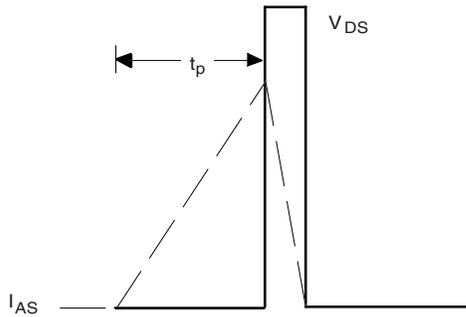


Fig. 13 - Unclamped Inductive Waveforms

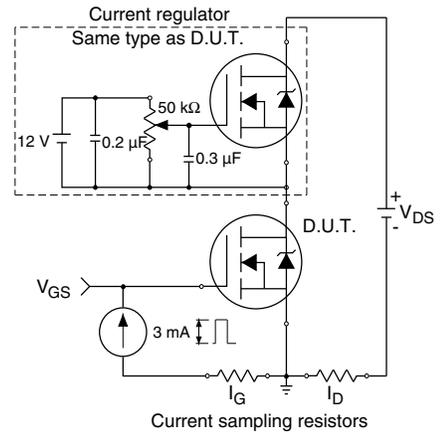


Fig. 15 - Gate Charge Test Circuit

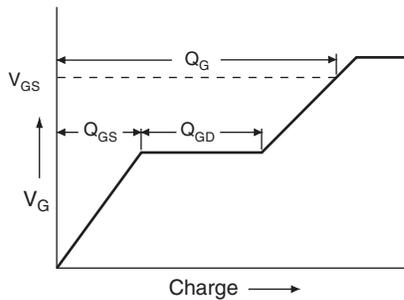
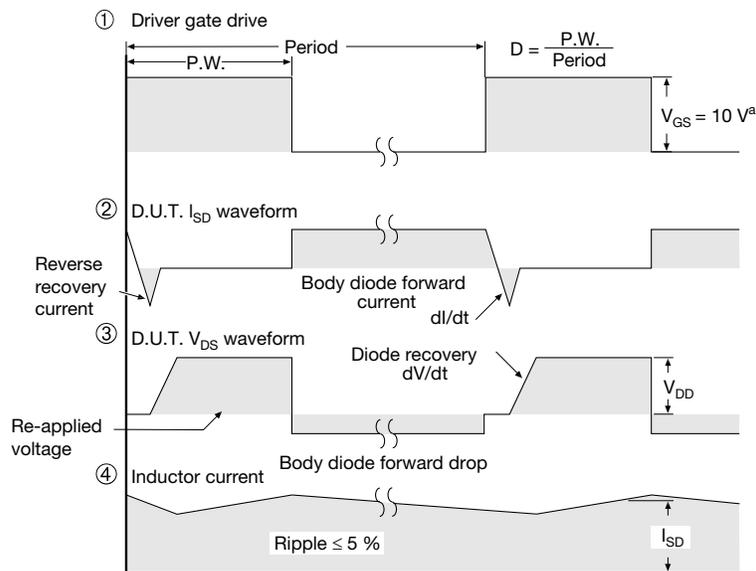
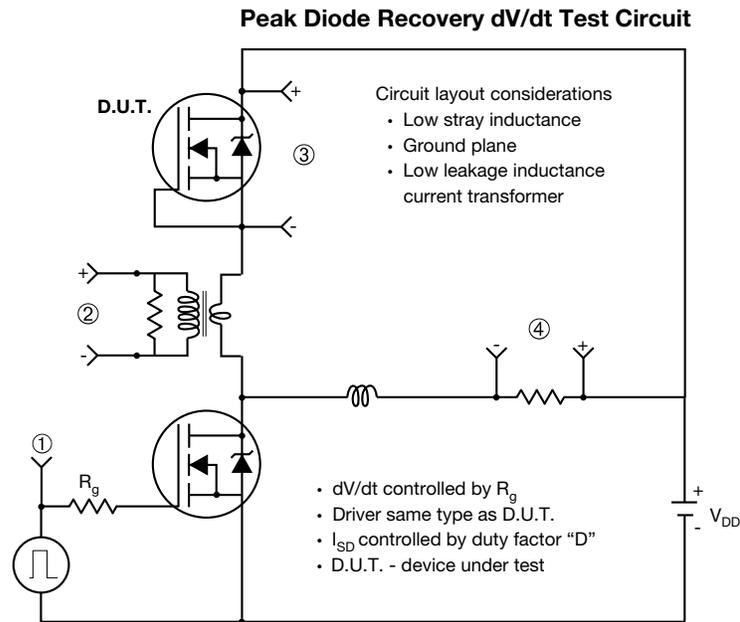


Fig. 14 - Basic Gate Charge Waveform



Note

a. $V_{GS} = 5\text{ V}$ for logic level devices

Fig. 16 - For N-Channel

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